

2008 IEEE International Conference on Web Services (ICWS 2008)

Sponsorship Program



The 2008 IEEE International Conference on Web Services (ICWS 2008) is sponsored by the IEEE Computer Society Technical Committee on Services Computing (TCSVC, <http://tab.computer.org/tcsc>). ICWS 2008 will be held on July 7-11, 2008, Hawaii, USA, co-located with SCC 2008. All the sponsors will automatically become the sponsors of the IEEE SOA Industry Summit, a co-located industry event with ICWS 2008. Please indicate which level and how much money you would like to sponsor:

Silver Level _____ (US Dollars)

Amount: **>= 5,000 US Dollars**

Benefit:

- Your logo will be put on the conference web site
- Your logo will be put in the IEEE ICWS 2008 Conference Proceedings and final printed advance program
- Your company name will be listed in the acknowledgment part in published IEEE ICWS 2008 Conference Proceedings
- Company publications (maximum of 2 pages) inserted into conference bags
- One complementary full conference registration

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Benefit:

- **Silver Level**
- A free exhibition booth at ICWS 2008 and one free exhibition staff pass
- 15-minute presentation opportunity at the Conference Dinner

Platinum Level _____ (US Dollars)

Amount: **>=15,000 US Dollars**

Benefit:

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- 30-minute presentation opportunity at the Conference Dinner
- **A Certificate for Appreciation Presented by IEEE ICWS 2008**

Additional conference registration fee: _____

Total: \$ _____

Your Company Name in Print: _____

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Full payment must accompany form. Forms and payment must be received by April 18, 2008, otherwise, your company logo cannot be printed in the IEEE ICWS 2008 Conference Proceedings.

Payment should be made to the IEEE ICWS 2008. Contact sponsor AT servicescomputing.org.